## EGF1A, EGF1B, EGF1C, EGF1D

Vishay General Semiconductor

## Surface-Mount Glass Passivated Ultrafast Rectifier

### Superectifier®



GF1 (DO-214BA)

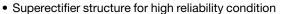


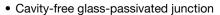
#### LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	1.0 A					
V <sub>RRM</sub> 50 V, 100 V, 150 V, 200						
I <sub>FSM</sub> 30 A						
t <sub>rr</sub>	50 ns					
V <sub>F</sub>	1.0 V					
T <sub>J</sub> max.	175 °C					
Package	GF1 (DO-214BA)					
Circuit configuration	Single					

#### **FEATURES**







• Ideal for automated placement

- · Ultrafast reverse recovery time
- · Low switching losses, high efficiency
- High forward surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C
- AEC-Q101 qualified
  - Automotive ordering code: base P/NHE3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **TYPICAL APPLICATIONS**

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

### **MECHANICAL DATA**

**Case:** GF1 (DO-214BA), molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3\_X - RoHS-compliant and AEC-Q101 qualified ("X" denotes revision code e.g. A, B, ...)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 and HE3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT	
Device marking code		EA	EB	EC	ED		
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	V	
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	V	
Maximum DC blocking voltage	$V_{DC}$	50 100 150 200			V		
Maximum average forward rectified current at T <sub>L</sub> = 125 °C	I <sub>F(AV)</sub>	1.0				Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	30			Α		
Operating junction and storage temperature range	$T_J$ , $T_{STG}$	-65 to +175				°C	

# EGF1A, EGF1B, EGF1C, EGF1D

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT
Maximum instantaneous forward voltage	1.0 A		V <sub>F</sub> <sup>(1)</sup>	V <sub>F</sub> <sup>(1)</sup> 1.0			V	
Maximum DC reverse current		T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(1)</sup>	5.0				μA
at rated DC blocking voltage	T <sub>A</sub> = 125 °C		'R ' '		5	0		μΑ
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t <sub>rr</sub>	50			ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15			pF	

#### Note

<sup>(1)</sup> Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER SYMBOL EGF1A EGF1B EGF1C EGF1D					UNIT	
Typical thermal registance	R <sub>0JA</sub> (1)	85				°C/W
Typical thermal resistance		30				O/VV

#### Note

<sup>(1)</sup> Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
EGF1D-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel			
EGF1D-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and reel			
EGF1DHE3_B/H (1)	0.104	Н	1500	7" diameter plastic tape and reel			
EGF1DHE3_B/I (1)	0.104	I	6500	13" diameter plastic tape and reel			

### Note

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise specified)

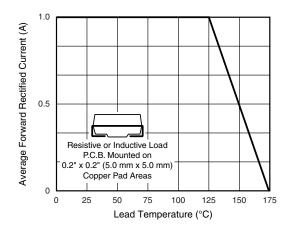


Fig. 1 - Maximum Forward Current Derating Curve

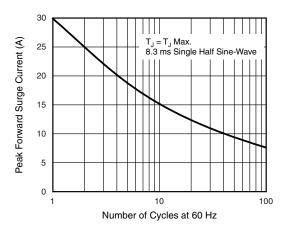


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

<sup>(1)</sup> AEC-Q101 qualified

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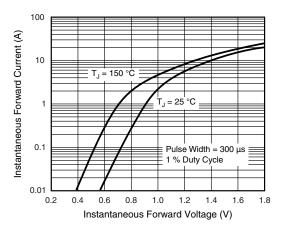


Fig. 3 - Typical Instantaneous Forward Characteristics

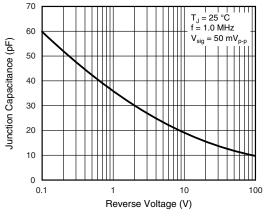


Fig. 5 - Typical Junction Capacitance

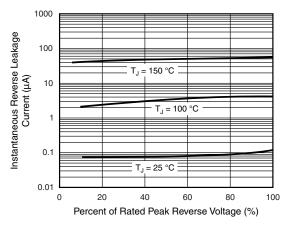


Fig. 4 - Typical Reverse Leakage Characteristics

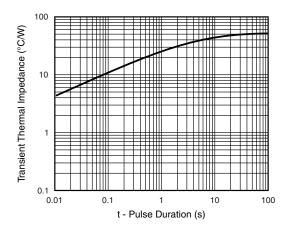
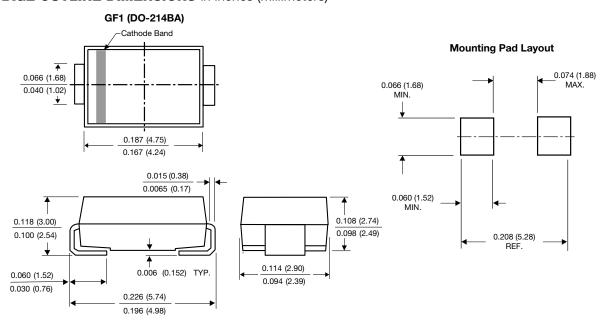


Fig. 6 - Typical Transient Thermal Impedance

### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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